



Bill of Materials

TI DESIGNS

TIDM-FILTERING-SIGNALPROCESSING-LEA

Item	Qty	Reference	Value	Part Description	Manufacturer	Manufacturer Part Number	Alternate Part	PCB Footprint	Note
1	1			MSP430FR5994 LaunchPad	Texas Instruments	MSP-EXP430FR5994			Click Here
2	1			Audio BoosterPack	Texas Instruments	BOOSTXL-AUDIO			Click Here
3	1			Sharp Graphics LCD BoosterPack	Texas Instruments	430BOOST-SHARP96			Click Here



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